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## HMC697LP4 / 697LP4E

v03.0712



# SiGe WIDEBAND DIRECT QUADRATURE MODULATOR, 200 - 4000 MHz

### Typical Applications

The HMC697LP4(E) is Ideal for:

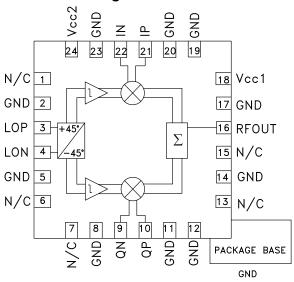
- UMTS, GSM or CDMA Basestations
- Fixed Wireless or WLL
- ISM Transceivers, 900 & 2400 MHz
- GMSK, QPSK, QAM, SSB Modulators
- Cellular/3G and WiMAX/4G

#### **Features**

Very Low Noise Floor, -165 dBm/Hz Excellent Carrier & Sideband Suppression Very High Linearity, +22 dBm OIP3 High Output Power, +9 dBm Output P1dB High Modulation Accuracy

24 Lead 4x4 mm QFN Package: 16 mm<sup>2</sup>

### **Functional Diagram**



### **General Description**

The HMC697LP4(E) is a low noise, high linearity Direct Quadrature Modulator RFIC which is ideal for digital modulation applications from 0.2 to 4.0 GHz including; Cellular/3G, WiMAX/4G, Broadband Wireless Access & ISM circuits. Housed in a compact 4x4 mm (LP4) SMT QFN package, the RFIC requires minimal external components & provides a low cost alternative to more complicated double upconversion architectures. The RF output port is single-ended and matched to 50 Ohms with no external components. The LO requires -6 to +6 dBm and can be driven in either differential or single-ended mode. This device is optimized for a +5V supply, and offers improved carrier feedthrough and sideband suppression characteristics.

### **Electrical Specifications**, See Test Conditions on following page herein.

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, RF		450 - 960	)	1	700 - 220	0	22	200 - 270	00	34	100 - 40	00	MHz
Output P1dB		+8			+8			+8			+7		dBm
Output Noise Floor		-167			-165			-165			-165		dBm/Hz
Output IP3		+23			+22			+22			+20		dBm
Output Power	2	4		1.5	3.5		1	3		0	2		dBm
Carrier Feedthrough (uncalibrated)		-38			-38			-40			-33		dBm
Sideband Suppression (uncalibrated)		43			42			43			45		dBc
LO Port Return Loss		12			15			14			8		dB
RF Port Return Loss		25			17			15			16		dB

## HMC697\* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

## COMPARABLE PARTS 🖳

View a parametric search of comparable parts.

### **EVALUATION KITS**

· HMC697LP4 Evaluation Board

### **DOCUMENTATION**

#### **Data Sheet**

• HMC697 Data Sheet

### REFERENCE MATERIALS -

### **Quality Documentation**

- Package/Assembly Qualification Test Report: LP4, LP4B, LP4C, LP4K (QTR: 2013-00487 REV: 04)
- Semiconductor Qualification Test Report: SiGe HBT-B (QTR: 2013-00236)

## **DESIGN RESOURCES**

- HMC697 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

### **DISCUSSIONS**

View all HMC697 EngineerZone Discussions.

### SAMPLE AND BUY 🖵

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### **TECHNICAL SUPPORT**

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### HMC697LP4 / 697LP4E

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# SiGe WIDEBAND DIRECT QUADRATURE MODULATOR, 200 - 4000 MHz

### Electrical Specifications, (continued)

Parameter	Conditions	Min.	Тур.	Max.	Units
RF Output		•			
RF Frequency Range		200		4000	MHz
RF Return Loss			15		dB
LO Input					
LO Frequency Range		200		4000	MHz
LO Input Power		-6	0	+6	dBm
LO Port Return Loss			12		dB
Baseband Input Port					
Baseband Input DC Voltage (Vbbdc)		+1.4	+1.5	+1.6	V
Baseband Input DC Bias Current (Ibbdc)	Single-ended.		90		μA
Single-ended Baseband Input Capacitance	De-embed to the lead of the device.		4.5		pF
DC Power Requirements See Test Conditions Below					
Supply Voltage (Vcc1, Vcc2)		+4.5	+5.0	+5.5	V
Supply Current (Icc1 + Icc2)			168		mA

### Test Conditions: Unless Otherwise Specified, the Following Test Conditions Were Used

Parameter		Condition	
Temperature		+25 °C	
Baseband Input Frequency	200 kHz		
Baseband Input DC Voltage (Vbbdc)		+1.5V	
Baseband Input AC Voltage	(Peak to Peak Differential, I and Q)	1.6V	
Baseband Input AC Voltage for OIP3 Measurement	(Peak to Peak Differential, I and Q)	800 mV per tone @ 150 & 250 kHz	
Frequency Offset for Output Noise Measurements		20 MHz	
Supply (Vcc1, Vcc2)		+5.0V	
LO Input Power		0 dBm	
LO Input Mode		Single-Ended through LOP	
Mounting Configuration		Refer to HMC697LP4(E) Application Schematic Herein	
Sideband & Carrier Feedthrough		Uncalibrated	

#### Calibrated vs. Uncalibrated Test Results

During the Uncalibrated Sideband and Carrier Suppression tests, care is taken to ensure that the I/Q signal paths from the Vector Signal Generator (VSG) to the Device Under Test (DUT) are equal. The "Uncalibrated, +25 °C" Sideband and Carrier Suppression plots were measured at room temperature, while the "Uncalibrated, over Temperature" Sideband and Carrier Suppression plots represent the worst case uncalibrated suppression levels measured at T= -40 °C, +25 °C, and +85 °C.

The "Calibrated, +25 °C" Sideband Suppression data was plotted after a manual adjustment of the I/Q amplitude balance and I/Q phase offset (skew) at +25 °C, and at each LO input power level. The +25 °C adjustment settings were held constant during tests over temperature. The "Calibrated, over Temperature" plots represent the worst case calibrated Sideband Suppression levels at T=-40 °C, +25 °C, and +85 °C.

The "Calibrated, +25 °C" Carrier Suppression data was plotted after a manual adjustment of the lp/ln & Qp/Qn DC offsets at +25 °C, and at each LO input power level. The +25 °C adjustment settings were held constant during tests over temperature. The "Calibrated, over Temperature" plots represent the worst case Carrier Suppression levels measured at T= -40 °C, +25 °C, and +85 °C.

#### Interfacing the HMC697LP4(E) with D/A Converters

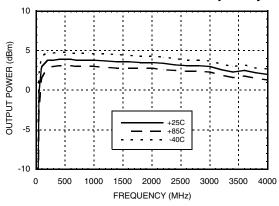
The HMC697LP4(E) wideband I/Q modulator is suitable to interface with high-speed D/A converters (DAC) to transmit complex modulation schemes. Please refer to the Product Application Note titled "Interfacing the HMC697LP4(E) with D/A Converters" for further information.



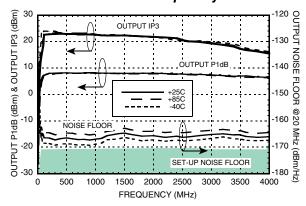


## SiGe WIDEBAND DIRECT QUADRATURE MODULATOR, 200 - 4000 MHz

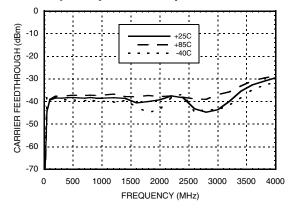
### Wideband Performance vs. Frequency



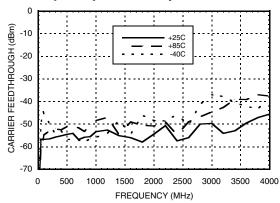
### Output IP3, P1dB & Noise Floor @ 20 MHz Offset vs. Frequency



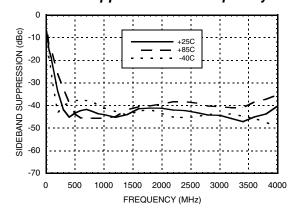
## Uncalibrated Carrier Feedthrough [1] vs. Frequency Over Temperature



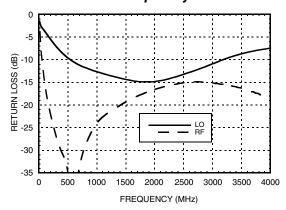
## Calibrated Carrier Feedthrough (1) vs. Frequency Over Temperature



### Sideband Suppression vs. Frequency



### Return Loss vs. Frequency



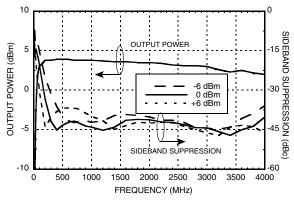
[1] See note titled "Calibrated vs. Uncalibrated test results" herein.



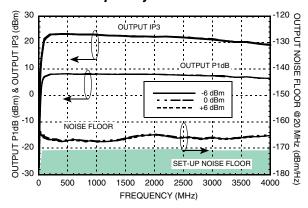


## SiGe WIDEBAND DIRECT QUADRATURE MODULATOR, 200 - 4000 MHz

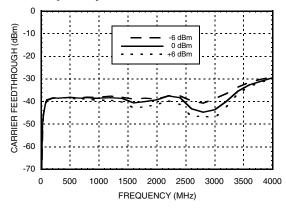
## Wideband Performance vs. Frequency Over LO Power



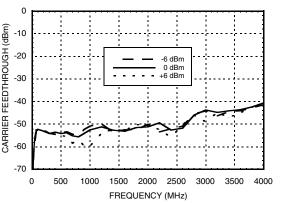
### Output IP3, P1dB & Noise Floor @ 20 MHz Offset vs. Frequency Over LO Power



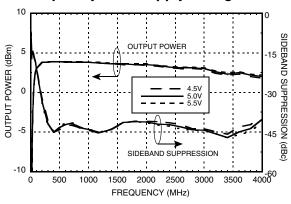
## Uncalibrated Carrier Feedthrough [1] vs. Frequency Over LO Power



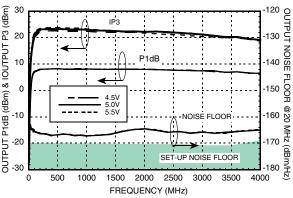
## Calibrated Carrier Feedthrough [1] vs. Frequency Over LO Power



## Wideband Performance vs. Frequency Over Supply Voltage



### Output IP3, P1dB & Noise Floor @ 20 MHz vs. Offset Frequency Over Supply Voltage



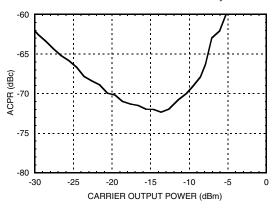
[1] See note titled "Calibrated vs. Uncalibrated test results" herein.





## SiGe WIDEBAND DIRECT QUADRATURE MODULATOR, 200 - 4000 MHz

### ACPR for W-CDMA @ 2140 MHz, 1 Carrier



Note 1: W-CDMA (Modulation Set-up for ACPR Mode); The Baseband I and Q input signals were generated using "Test Model 1 with 64 channels" settings in the Agilent E3844C.

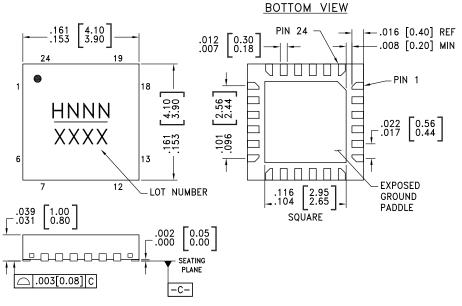
Note 2: The I/Q baseband amplitude and phase inputs were offset to achieve Sideband Rejection (SBR) levels. LO = +6 dBm, SSB Power = 0 dBm

### **Absolute Maximum Ratings**

Vcc1, Vcc2	0V to +6V	
LO Input Power	+18 dBm	
Baseband Input Voltage (AC + DC) (Reference to GND)	0V to + 2.8V	
Junction Temperature	150 °C	
Continuous Pdiss (T = 85°C) (Derate 49.6 mW/°C above 85°C)	3.2 Watts	
Thermal Resistance (R <sub>th</sub> ) (channel to ground paddle)	20.2 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	
ESD Sensitivity (HBM)	Class 1A	



### **Outline Drawing**



### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]	
HMC697LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H697 XXXX	
HMC697LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H697 XXXX	

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260  $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX





# SiGe WIDEBAND DIRECT QUADRATURE MODULATOR, 200 - 4000 MHz

### **Pin Descriptions**

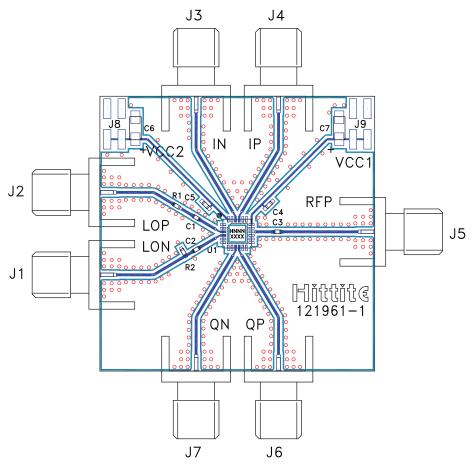
Pin Number	Function	Description	Interface Schematic
1, 6, 7, 13, 15	N/C	Not connected.	
2, 5, 8, 11, 12, 14, 17, 19, 20, 23	GND	These pins and the ground paddle should be connected to a high quality RF/DC ground.	→ GND —
3, 4	LOP, LON	LO inputs. Need DC decoupling capacitors. The ports could be driven single ended or differentially.	Vcc o o LO
9, 10	QN, QP	Q channel differential baseband input. These high impedance ports should be biased around 1.5V DC. Nominal recommended baseband input is around 1.6V pp differential.	QN,QP 50 n
16	RFOUT	DC coupled and matched to 50 Ohms, output requires blocking capacitor.	OVcc1
18	Vcc1	Supply voltage for the mixer and output stages 79 mA @ +5V.	Vcc1 O OUTPUT STAGE
21, 22	IP, IN	I channel differential baseband input. These high impedance ports should be at the same bias voltage (VbbDC) as Qn & Qp.	IP, IN 50 0
24	Vcc2	Supply voltage for the LO stage 88 mA @ +5V.	Vcc2 O





## SiGe WIDEBAND DIRECT QUADRATURE MODULATOR, 200 - 4000 MHz

#### **Evaluation PCB**



### List of Materials for Evaluation PCB 121965[1]

Item	Description	
J1 - J7	PC Mount SMA Connector	
J8, J9	DC Molex Connector	
C1 - C3	100 pF Chip Capacitor, 0402 Pkg.	
C4, C5	1000 pF Chip Capacitor, 0402 Pkg.	
C6, C7	4.7 uF, Case A, Tantalum	
R1	0 Ohm Resistor, 0402 Pkg.	
R2	49.9 Ohm Resistor, 0402 Pkg.	
U1	HMC697LP4 Modulator	
PCB [2]	121961 Eval Board	

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

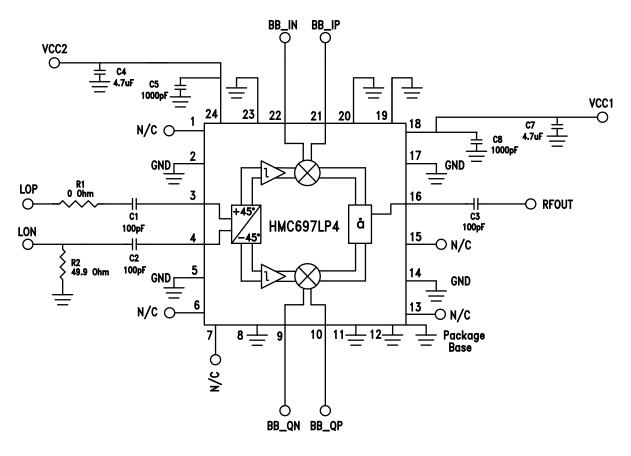
The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.





## SiGe WIDEBAND DIRECT QUADRATURE MODULATOR, 200 - 4000 MHz

### **Application & Evaluation PCB Schematic**



### **Characterization Set-up**

